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Electronic Patent Application Submission

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EFS ID: 59486
Application ID: 10608404
Title of Invention: METHOD AND COMPOSITION
FOR POLISHING A SUBSTRATE
First Named Inventor: FENG LIU
Domestic/Foreign Application: Domestic Application
Filing Date: 2003-06-26
Effective Receipt Date: 2004-04-22
Submission Type: Information Disclosure
Statement
Filing Type:
Confirmation number: 7966
Attorney Docket Number: AMAT5699P3
Total Fees Authorized: 180.0
Payment Category: Deposit Account
Deposit Account Number: 200782
Deposit Account Name: BRIAN K. HRNA
Access Code: ****
RAM Payment Status: RAM success
RAM User ID: EFSPROD
RAM Accounting Date: 2004-04-22
RAM Sequence Number: 9




Digital Certificate Holder: cn=Brian K. Hrna,ou=Registered Attorneys,ou=Patent and Trademark
Office,ou=Department of Commerce,o=U.S. Government,c=US
Certificate Message Digest: ddee75a8747693f078049f21b9fb39ac2095df80



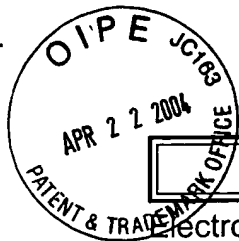
TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	METHOD AND COMPOSITION FOR POLISHING A SUBSTRATE	
<p>Application Number: 10/608404 </p> <p>Date: 2003-06-26</p> <p>First Named Applicant: FENG Q. LIU</p> <p>Confirmation Number: 7966</p> <p>Attorney Docket Number: AMAT5699P3</p>		
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Submitted by:	Elec. Sign.	Sign. Capacity
BRIAN K. HRNA Registered Number: 41,852	[BRIAN K. HRNA]	Attorney
Documents being submitted	Files	
us-fee-sheet	AMAT5699P3BKH-usfees.xml	
	us-fee-sheet.xsl	
	us-fee-sheet.dtd	
us-ids	AMAT5699P3BKH-usidst.xml	
	us-ids.dtd	
	us-ids.xsl	

Comments

**FEE TRANSMITTAL**

Electronic Version v08

Stylesheet Version v08.0

**Title of
Invention****METHOD AND COMPOSITION FOR POLISHING A SUBSTRATE**

Application Number: 10/608404 
Date: 2003-06-26
First Named Applicant: FENG Q. LIU
Attorney Docket Number: AMAT5699P3
Art Unit: 1765

TOTAL FEE AUTHORIZED \$180

Patent fees are subject to annual revisions on or about October 1st of each year.

BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$
Submission Of Information Disclosure Stmt Fee	1806	180	180

AUTHORIZED BILLING INFORMATION

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Deposit account number: 200782

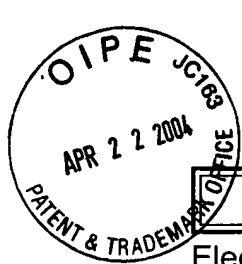
Access Code *****

Deposit name: MOSER PATTERSON SHERIDAN

Deposit authorized name: BRIAN K. HRNA


Signature: /BRIAN K. HRNA/

Date (YYYYMMDD): 2004-04-22



FEE TRANSMITTAL

Electronic Version v08
Stylesheet Version v08.0


Title of Invention	METHOD AND COMPOSITION FOR POLISHING A SUBSTRATE										
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Art Unit: 1765											
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BASIC FILING FEE											
<table border="1"><thead><tr><th>Fee Description</th><th>Fee Code</th><th>Amount \$</th><th>Fee Paid \$</th></tr></thead><tbody><tr><td>Submission Of Information Disclosure Stmt Fee</td><td>1806</td><td>180</td><td>180</td></tr></tbody></table>				Fee Description	Fee Code	Amount \$	Fee Paid \$	Submission Of Information Disclosure Stmt Fee	1806	180	180
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Signature: /BRIAN K. HRNA/											
Date (YYYYMMDD): 2004-04-22											



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	METHOD AND COMPOSITION FOR POLISHING A SUBSTRATE						
<div>Application Number: 10/608404 </div> <div>Confirmation Number: 7966</div> <div>First Named Applicant: FENG LIU</div> <div>Attorney Docket Number: AMAT5699P3</div> <div>Art Unit: 1765</div> <div>Search string: (6693036 or 6679929 or 6679928 or 6676484 or 6620215 or 6616976 or 6605537 or 6602112 or 6596638 or 6593239 or 6565619 or 6562719 or 6551935 or 6508952 or 6455479 or 6454819 or 6447371 or 6440186 or 6429133 or 6428721 or 6419554 or 6375693 or 6315883 or 6315803 or 6310019 or 6303551 or 6303049 or 6273786 or 6258721 or 6258711 or 6248222 or 6238592 or 6206756 or 6176992 or 6171352 or 6117783 or 6103096 or 6099604 or 6083840 or 6063306 or 6066030).pn.</div>							
US Patent Documents							
Note: Applicant is not required to submit a paper copy of cited US Patent Documents							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6693036	2004-02-17	Nogami, et al.			
	2	6679929	2004-01-20	Asano, et al.			
	3	6679928	2004-01-20	Costas, et al.			
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	39	6083840	2000-07-04	Mravic, et al.
	40	6063306	2000-05-16	Kaufman, et al.
	41	6066030	1999-08-15	Datta

Signature

Examiner Name	Date